

Mica wafers

<p>art. no. GS 3 TO-3</p>	<p>art. no. GS 4 D TO 93</p>	<p>art. no. GS 5 D TO 93</p>	<p>art. no. GS 66 P TO 66</p>	<p>art. no. GS 3 P TOP 3</p>
<p>art. no. GS 32 P SOT 32</p>	<p>art. no. GS 218 TO 218</p>	<p>art. no. GS 220 P TO 220</p>	<p>art. no. GS 220 4 TO 220</p>	<p>art. no. GS 3 P SL TOP 3</p>
<p>art. no. GS 220 C TO 220</p>				

material	muskovit
material thickness	0.05 mm
insulation resistance	$3 \times 10^{17} \Omega/\text{cm}$
thermal resistance (AOS 3)	0.4 K/W
snap through stability	5 kV

E 11

Profiles for PCB components
Heatsinks for PCB
Profiles for PCB mounting
Heatsinks for transistors

→ A ?
→ A ? - ?
→ A ? - ?
→ C ? - ?

Finger-shaped heatsinks
Distance sleeves
Spacers
GEL thermal conductive foil

→ C ? - ?
→ E ? - ?
→ E ? - ?
→ E 7